

# **Automated X-ray inspection system**

- Transmission
- Off-axis
- 3D SART



The **X3** is an automatic X-Ray inspection system featuring combined Transmission and 3D Technology for sophisticated high-speed inspection in electronic production. The system is based on the motion concept of the MatriX X2.5 AXI system. A newly developed 3D reconstruction software generates slice images for 3D analysis of solder joints. Main applications are double-sided boards with critical overlapping areas.

MIPS\_Tune is an off-line programming software package for test program generation with automatic CAD import or alternatively without CAD data. It features automated inspection list generation based on an advanced algorithm library for transmission and off-axis joint inspection.

Proprietary **Tree-Classification** technique with integrated automatic rule generation, graphical measurement & yield display for program optimization.

The verification software module **MIPS\_Verify** with its closed-loop repair concept is capable of in-line or off-line verification using a graphical board layout display and X-ray image with defect marking.

**MIPS\_Verify** supports parallel display of off-axis, transmission and optical images of the same defect for easy and reliable defect verification.

**MIPS\_SPC** is a process control tool for real-time and history statistics

## SYSTEM FEATURES

- Transmission X-ray & 3D technology
- 130 kV microfocus X-ray tube (sealed)
- 5 axes programmable motion
- Digital Flat Panel Detector on u/v motion table for 360° angle-shot coverage
- · In-line board handling with automated width adjust
- Pass-through mode with integrated lift conveyor technique
- · Automatic grey-level and geometrical calibration
- Barcode scanner (1D/2D) for serial number and product type selection

## **FEATURES**

## MATRIX INSPECTION & PROCESS SOFTWARE

### **MIPS Hardware**

- PC-Station with multi-core processor setup
- · Windows 7 platform

## **MIPS Inspection Platform**

- Advanced algorithm library for solder-joint and component inspection
- Simultaneous Algebraic Reconstruction Technique (SART)
- Automatic Tree Classification (ATC) for Auto-Rule-Generation
- Off-line programming for AXI program generation & simulation, tuning and defect reference catalogue

### **Verification & process control**

- · MIPS\_Verify link with closed loop repair
- MIPS\_Process with real time SPC

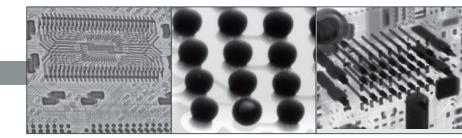




# Automated X-ray Inspection System Transmission, off-axis & 3D SART



# **APPLICATIONS**



### ELECTRONIC COMPONENTS AND SOLDER-JOINTS

A unique advanced algorithm library is available for electronic applications specifically for component and solder-joint inspection on PCB, hybrid or chip level assembly processes

- All standard SMDs and THT/PTH components
- Specific BGA and QFN algorithm
- Off-axis image analysis for BGA Head-in-pillow or THT/PTH Barrel Fill measurement

· Cooling plates/heatsink void inspection

### ALGEBRAIC 3D RECONSTRUCTION

The newly developed algebraic reconstruction algorithm for 3D analysis is the highlight of the inline 3D system X3. It requires only few projections for generation of detailed, high resolution slice images. In addition the algorithm is independent of geometries and therefore offers optimum flexibility with respect to the acquisition setup.

## **SPECIFICATIONS**

**Physical Dimension** 

Safe Operating Tempe	rature15° - 32 °C
Power Consumption	max. 6 kW
	400 VAC, 50/60 Hz 3 phase, 16 A
	208 VAC, 50/60 Hz 3 phase, 25 A
All	5-7 Bar, $<$ 2 l/min, filtered (30 $\mu$ ), dry, oil free
Mation Custom	
Motion System	
	ole with linear drives (X,Y)
	510 x 405 mm
Position Repeatability	+/- 5 μm
X-Ray tube (Z)	0 - 150 mm
Detector Axes (U,V)	220 x 200 mm
X-ray Source (sealed	tube)
-	130 kV/40 W
	5 - 7 microns
	n End window tube
A-nay Tube Offeritation	I Lifd willdow tube
Divital Image Datasta	
Digital Image Detecto	
	14 bit
	Camera link interface
Detector Type A	
Active inspection area	115 x 115 mm
Detector Type B	CMOS Detector (2k x 2k)
Active inspection area	
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Image Performance Angle shot capability	0 – 45 dgr
Transmission FoV	, , , , , , , , , , , , , , , , , , , ,
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#### Safety / Regulatory

Full safe, interlocked enclosure. Complies with all U.S. and International standards for cabinet radiography systems. CDRH directives / CE compliant.